

6-103669-0 ✓ ACTIVE

AMPMODU | AMPMODU MTE

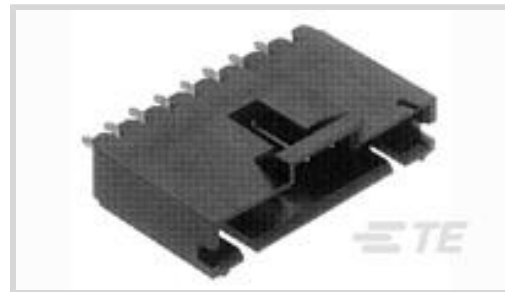
TE Internal #: 6-103669-0

PCB Mount Header, Vertical, Wire-to-Board, 11 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU MTE

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Connectors > PCB Connectors > PCB Headers & Receptacles



EU RoHS Compliance: **Compliant**

EU ELV Compliance: **Compliant**

PCB Connector Assembly Type: **PCB Mount Header**

PCB Mount Orientation: **Vertical**

Connector System: **Wire-to-Board**

Features

Other

EU RoHS Compliance **Compliant**

EU ELV Compliance **Compliant**

Product Type Features

PCB Connector Assembly Type **PCB Mount Header**

Connector System **Wire-to-Board**

Header Type **Fully Shrouded**

Sealable **No**

Connector & Contact Terminates To **Printed Circuit Board**

Configuration Features

PCB Mount Orientation **Vertical**

Number of Positions **11**

Number of Rows **1**

Electrical Characteristics

Termination Resistance **15 mΩ**

Insulation Resistance **5000 MΩ**

Dielectric Withstanding Voltage (Max) **600 V**

Body Features

Primary Product Color **Black**



Contact Features

PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Thickness	2.54 μm [100 μin]
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.54 μm [100 μin]
Contact Shape & Form	Square
Contact Mating Area Length	5.84 mm[.23 in]
Contact Base Material	Brass
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material Finish	Bright
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A

Termination Features

Termination Post & Tail Length	3.3 mm[.13 in]
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Method to PCB	Through Hole - Solder

Mechanical Attachment

Mating Retention Type	Hold-Down
Mating Retention	With
Mating Alignment Type	Latched, Polarization
PCB Mount Retention Type	Swaged Retention Tails
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	With

Housing Features

Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]

Dimensions

PCB Thickness (Recommended)	1.57 mm[.062 in]
Connector Height	13.59 mm[.535 in]



Connector Length	30.48 mm[1.2 in]
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Usage Conditions

Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
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Operation/Application

Circuit Application	Signal
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Industry Standards

Compatible With Approved Standards Products	UL E28476, CSA LR7189
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UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Quantity	17
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Packaging Method	Tube, Box
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Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
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EU ELV Directive 2000/53/EC	Compliant
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China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
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EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
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Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
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Solder Process Capability	Reflow solder capable to 260°C
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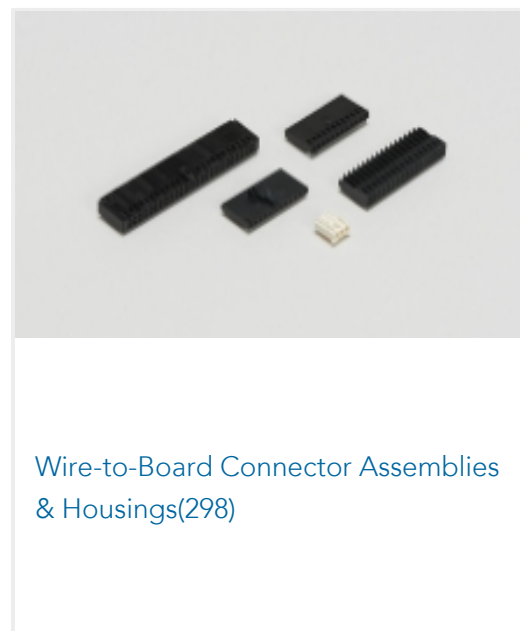
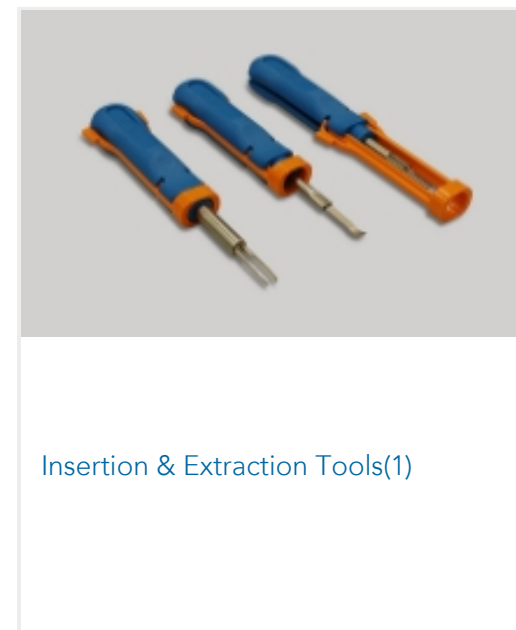
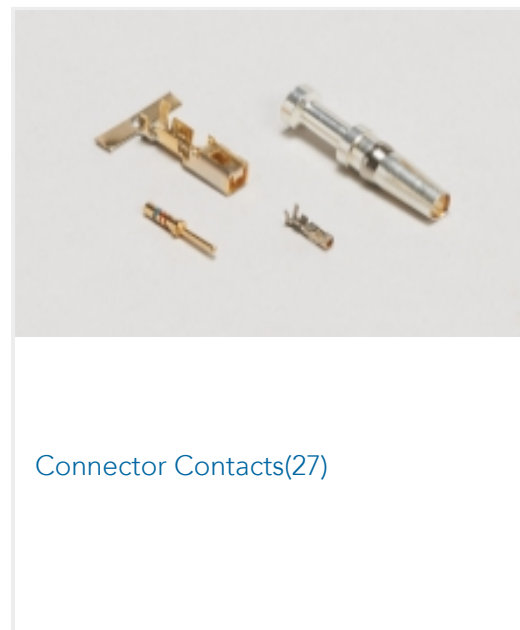
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

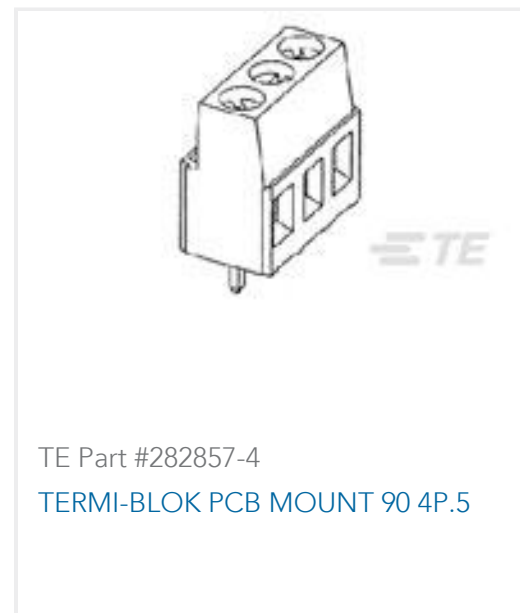


Also in the Series | AMPMODU MTE



Customers Also Bought





Documents

Product Drawings

11 MTE HDR SRST LATCH W/HLDWN

English

CAD Files

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_6-103669-0_AB.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_6-103669-0_AB.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_6-103669-0_AB.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

[AMP MODU MTE Section of Catalog 1307819](#)

English

[AMPMODU_INTERCONNECTION_SYSTEM_SECTION5_CONT](#)

English

[AMPMODU MTE INTERCONNECT SYSTEM](#)

English

Product Specifications



Application Specification

English